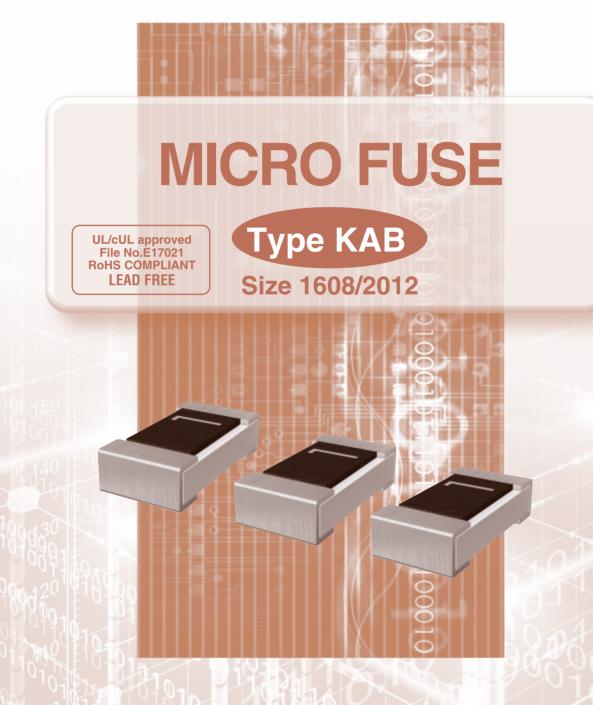
PRODUCTS DATA SHEET



MATSUO ELECTRIC CO., LTD.

Type KAB micro fuse is designed for circuit protection against excessive current in portable electronic equipment, electronic circuit around battery, etc. because the demand for high capacity batteries is increasing.

Further miniaturization and low profile with extended rated range can be used for wider application.

Also, the ecology design of Type KAB is gentle to the environment due to complete lead free.

FEATURES

- 1. New type fuses developed by our original technology. They show no variation in fusing characteristics and have excellent fastblow capability.
- 2. Surface temperature rise is 75°C or less when applying rated current. This offers less influence on the peripheral units.
- 3. The fuses come in ultrasmall size 1608 (1.6 \times 0.8 \times 0.45 mm) and 2012 (2.0 \times 1.25 \times 0.5 mm).
- 4. Suitable for automatic mounting
- 5. Precise dimensions allows high-density mounting and symmetrical construction of terminals provide "Self-Alignment".
- 6. Resistance to soldering heat : Reflow or flow soldering 10 seconds at 260°C
- 7. High accuracy carrier tape by using pressed pocket paper ensures excellent mounting.
- 8. LEAD-FREE and RoHS Compliant

RATING

Item	Rating
Category Temperature Range	-40 ~ +125°C
Rated Current	1.6 × 0.8 0.2–0.25–0.315–0.4–0.5–0.63–0.8–1.0–1.25–1.6–2.0–2.5–3.15–4.0–5.0–6.3 A
Rated Current	2.0×1.25 0.2-0.25-0.315-0.4-0.5-0.63-0.8-1.0-1.25-1.6-2.0-2.5-3.15-4.0-5.0 A
Rated Voltage	24 VDC, 32 VDC, 50 VDC
Voltage Drop	Refer to CATALOG NUMBERS AND RATING
Insulation Resistance	1000 MΩ or more
(between Terminals and Case)	
Fusing Characteristics	Fusing within 1 min if the current is 200% of rated current.
Clearing Characteristics	Breaking voltage : 24 V, 32 V or 50 V
Clearing Characteristics	Breaking current : 50 A

ORDERING INFORMATION

		_K		320	2	102			2 9	<u>.</u>	010				
Т	jpe	Code	Voltage	Code	Rated curre	nt	Code	Rated curren	t	Code	Packaging type] [Code	Case size	Special product code
ĸ	AB	2402	24V	201	0.2 A		132	1.25 A		NA		11	29	1.6×0.8	010*
		3202	32V	251	0.25 A		162	1.6 A					31	2.0 imes 1.25	
		5002	50V	321	0.315 A		202	2.0 A							
				401	0.4 A		252	2.5 A							
				501	0.5 A		322	3.15 A							
				631	0.63 A		402	4.0 A							
				801	0.8 A		502	5.0 A							
				102	1.0 A		632	6.3 A							

*The special product code 010 indicates lead-free terminals.

CATALOG NUMBERS AND RATING

Catalog number	Case size	Rated current A	Internal resistance mΩ (Typical)	Voltage drop mV (Max.)	Rated voltage VDC	Breaking current A
KAB 5002 201 29 010*	1.6×0.8	0.2	1260	405		
KAB 5002 251 29 010	1.6×0.8	0.25	825	355		
KAB 5002 321 29 010	1.6×0.8	0.315	530	275	50	
KAB 5002 401 29 010	1.6×0.8	0.4	320	180		
KAB 5002 501 29 010	1.6×0.8	0.5	210	140		
KAB 3202 631 229 010	1.6 × 0.8	0.63	135	115]
KAB 3202 801 🗆 29 010	1.6×0.8	0.8	100	110		
KAB 3202 102 29 010	1.6×0.8	1.0	80	110	32	50
KAB 3202 132 29 010	1.6×0.8	1.25	60	110	32	50
KAB 3202 162 29 010	1.6×0.8	1.6	46	110		
KAB 3202 202 202 010	1.6×0.8	2.0	35	110		
KAB 2402 252 29 010	1.6×0.8	2.5	27	110		
KAB 2402 322 29 010	1.6×0.8	3.15	20	110		
KAB 2402 402 29 010	1.6×0.8	4.0	15	110	24	
KAB 2402 502 29 010	1.6×0.8	5.0	13	110		
KAB 2402 632	1.6×0.8	6.3	10	110		
KAB 2402 201 🗆 31 010	2.0×1.25	0.2	1740	480		
KAB 2402 251 🖂 31 010	2.0 × 1.25	0.25	1280	475		
KAB 2402 321 🗆 31 010	2.0 × 1.25	0.315	800	375		
KAB 2402 401 🖂 31 010	2.0 × 1.25	0.4	440	255		
KAB 2402 501 🖂 31 010	2.0 × 1.25	0.5	260	170		
KAB 2402 631 🔲 31 010	2.0 × 1.25	0.63	175	150		
KAB 2402 801	2.0 × 1.25	0.8	120	145		
KAB 2402 102 🖂 31 010	2.0 × 1.25	1.0	90	135	24	50
KAB 2402 132 🔲 31 010	2.0 × 1.25	1.25	67	130		
KAB 2402 162 010	2.0 × 1.25	1.6	48	120		
KAB 2402 202 031 010	2.0 × 1.25	2.0	36	115		
KAB 2402 252 🔲 31 010	2.0 × 1.25	2.5	28	110		
KAB 2402 322	2.0 × 1.25	3.15	21	105		
KAB 2402 402 🖂 31 010	2.0 × 1.25	4.0	16	95		
KAB 2402 502 🗆 31 010	2.0 × 1.25	5.0	10	60		

*For taping specification, the package code (NA) is entered in ___. One reel contains 5000 pcs.

DIMENSIONS





Main Body : Alumina ceramic

Terminal : Tin plating (mm)									
Case size	Case code	L	W	T max.	Р				
1608	29	1.6 ± 0.1	0.8 ± 0.1	0.45	0.3 ± 0.2				
2012	31	2.0 ± 0.1	1.25 ± 0.1	0.5	0.3 ± 0.2				

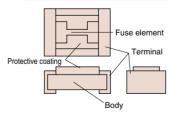
MARKING

Cod	Code : Rated current							
Р	:	0.2	А		W	:	1.25	Α
Q	:	0.25	Α		Х	:	1.6	Α
R	:	0.315	Α		2	:	2.0	A
S	:	0.4	Α		Υ	:	2.5	Α
Т	:	0.5	A		3	:	3.15	Α
U	:	0.63	Α		4	:	4.0	Α
V	:	0.8	Α		5	:	5.0	A
1	:	1.0	A		6	:	6.3	Α

RECOMMENDED PAD DIMENSIONS

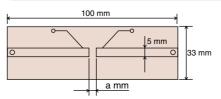
	,	↑		Size 1608	Size 2012
		b	a	1.0	1.4
			b	1.2	1.65
← a →← c →	< a >		с	1.0	1.2
		_			(mm)

CONSTRUCTION



Name	Material
Fuse element	Copper alloy
Body	Alumina ceramic
Protective coating	Silicone resin
Terminal	Tin plating

STANDARD TEST BOARD



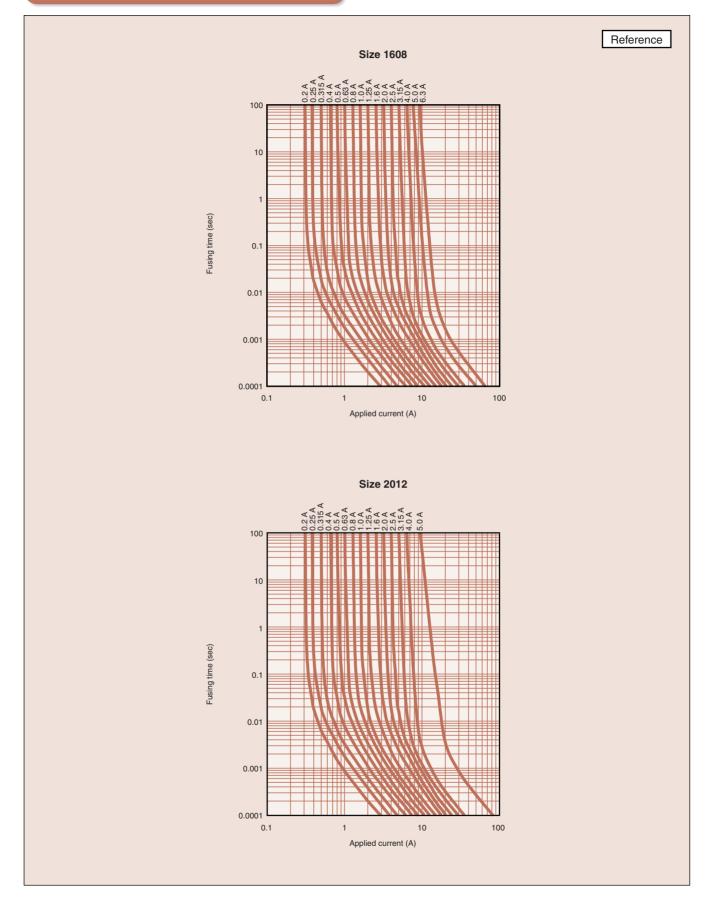
Glass epoxy on one side Board thickness : 1.6 mm Copper layer : 35 µm

		•
Cas	e size	Size a
10	608	1.2
2	012	1.5
		(mm)

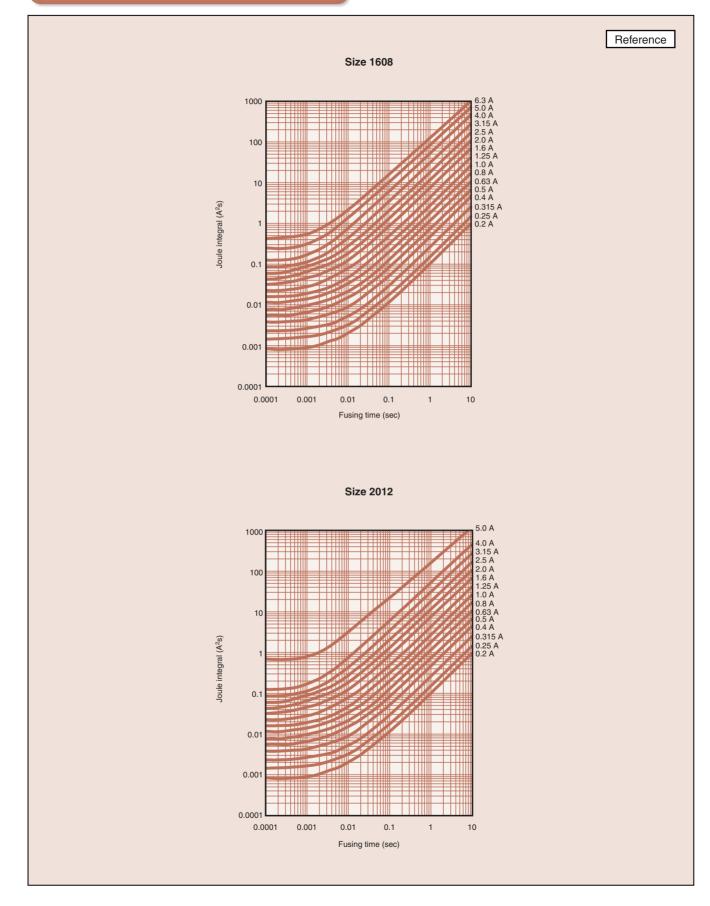
PERFORMANCE

No	Item	Performance	Test method
<u>No.</u>	Temperature rise	Temperature rise shall not exceed 75°C.	Apply rated current.
2	Current-carrying capacity	Shall not open within 1 hour.	Apply rated current.
3	Clearing characteristics	Arc shall not be continued. Marking shall be legible.	Breaking voltage : Rated voltage Breaking current : 50 A
4	Voltage drop	Voltage drop is below the value specified in CATALOG NUMBERS AND RATING.	Apply rated current.
5	Fusing characteristics	Fusing within 1 min.	Apply 200% of rated current. (Ambient temperature : 10 ~ 30°C)
6	Insulation resistance	1000 MΩ or more	Insulation resistance between terminals and case (alumina ceramic)
7	Electrode strength (Flexibility)	No mechanical damage. Shall meet the fusing characteristics.	Board supporting width : 90 mm Bending speed : Approx. 0.5 mm/sec Duration : 30 sec Bending : 3 mm
8	Shear test	No mechanical damage. Shall meet the fusing characteristics.	Applied force : 20 N (2.04 kgf) Duration : 10 sec Tool : R0.5 Direction of the press : side face
9	Substrate bending test	No mechanical damage. Shall meet the fusing characteristics.	Supporting dimension : 1.2 mm (size 2012) 0.8 mm (size 1608) Applied force : 10 N (1.02 kgf) Tool : R0.5 Direction of the press : thickness direction of product
10	Solderability	The dipped surface of the terminals shall be covered more than 95% with new solder.	Dipping : 3 sec Temperature : 245 ± 5°C Solder : Sn-3Ag-0.5Cu alloy Dipping : 3 sec Temperature : 235 ± 5°C
11	Resistance to soldering heat	Marking shall be legible. No mechanical damage. Shall meet the fusing characteristics.	Dipping (1 cycle) Preconditioning : $100 \sim 150^{\circ}$ C, 60 sec Temperature : $265 \pm 3^{\circ}$ C/6 ~ 7 sec Reflow soldering (2 cycles) Preconditioning : $1 \sim 2$ min, 180° C or less Peak : 260° C max, 5 sec Holding : $230 \sim 250^{\circ}$ C, $30 \sim 40$ sec Cooling : more than 2 min Manual soldering Temperature : $400 \pm 10^{\circ}$ C Duration : $3 \sim 4$ sec Measure after 1 hour left under room temp. and humidity.
12	Solvent resistance	Marking shall be legible. No mechanical damage. Shall meet the fusing characteristics.	Dipping rinse Solvent : Isopropyl alcohol Duration : 90 sec
13	Vibration	No mechanical damage. Shall meet the fusing characteristics.	Frequency range : 10 ~ 55 ~ 10 Hz/min Vibration amplitude : 1.5 mm Duration : 2 hours in each of XYZ directions (total : 6 hours)
14	Shock	No mechanical damage. Shall meet the fusing characteristics.	Peak value : 490 m/s² (50 G) Duration : 11 ms 6 aspects × 3 times (total : 18 times)
15	Thermal shock	No mechanical damage. Shall meet the fusing characteristics.	$\begin{array}{l} -55\pm3^\circ C:30\mbox{ min}\\ \mbox{Room temperature}:2\sim3\mbox{ min or less}\\ 125\pm2^\circ C:30\mbox{ min}\\ \mbox{Room temperature}:2\sim3\mbox{ min or less}\\ \mbox{Repeat above step for 10 cycles.} \end{array}$
16	Atomizing salt water	No mechanical damage. Shall meet the fusing characteristics.	Temperature : $35 \pm 2^{\circ}$ C Concentration (weight ratio) : $5 \pm 1\%$ Duration : 24 hours
17	Moisture resistance	No mechanical damage. Shall meet the fusing characteristics.	Temperature : 85 ± 3°C Humidity : 85 ± 5% RH Duration : 1000 hours
18	Load life	No mechanical damage. Shall meet the fusing characteristics.	Temperature : $85 \pm 2^{\circ}$ C Applied current : Rated current × 70% Duration : 1000 hours
19	Stability	No mechanical damage. Shall meet the fusing characteristics.	Temperature : 125 ± 2°C Duration : 1000 hours

FUSING CHARACTERISTICS

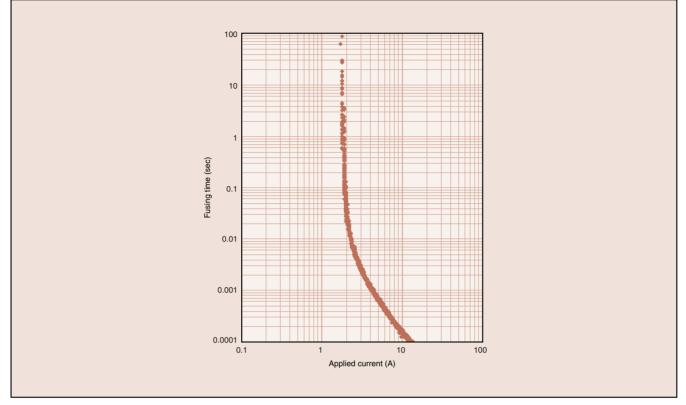


I²T-T CHARACTERISTICS



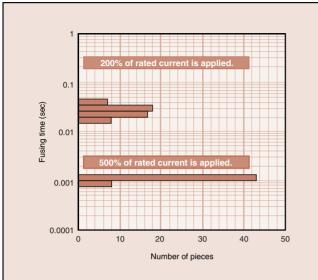
DISTRIBUTION OF FUSING CHARACTERISTICS

KAB 2402 102 n : 1158 pcs.

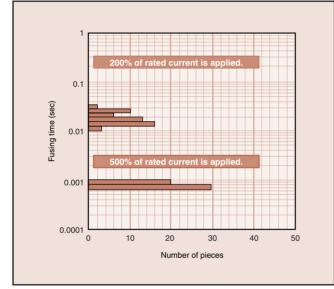


DISTRIBUTION OF FUSING TIME

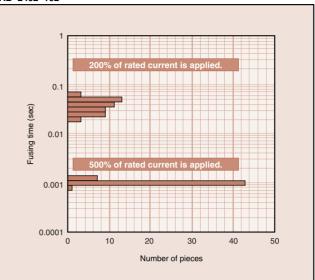
KAB 2402 801



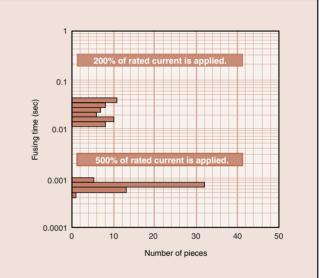




KAB 2402 102







DETERMINATION OF RATED VALUE AND SELECTION OF MICRO FUSE (TYPE KAB)

Determine the rated value of the microfuse, and select the correct microfuse for your circuit. If you select the correct microfuse, safety of your circuit can be ensured. How to determine the rated value of the microfuse is described below :

Flow for fuse selection

1. Measurement of circuit values using acute device	Measure the circuit values, such as operating current of the circuit.
2. Calculation from operating current	From the obtained operating current and the category temperature, calculate the <u>minimum rated</u> <u>value</u> to determine the applicable fuse.
3. Calculation from overload current	From the obtained overload current, calculate the maximum rated value to determine the applicable fuse.
4. Calculation from inrush current	From the inrush current, calculate the minimum rated value to determine the applicable fuse.
5. Final determination of rated value	From the calculation results of steps 2 through 4, determine the rated value.
6. Operation check using actual device	After selecting the rating, confirm if the device works properly under the pre-determined conditions.

Fuse selection

1. Measurement of circuit values using actual device

Before determining the rated value of the fuse, preliminarily measure the following using the actual device.

1-1 Operating current

Using an oscilloscope or equivalents, measure the operating current of the circuit.

1-2 Overload current

Using an oscilloscope or equivalents, measure the overload current that needs to break the circuit.

1-3 Inrush current

Using an oscilloscope or equivalents, measure the inrush current of the circuit at power-on or power-off. In addition, determine the number of inrush current applied.

1–4 Category temperature

Measure the ambient temperature of the fuse circuit.

EXAMPLE TO SELECT RATINGS OF TYPE KAB

<Fuse selection> Effective operating current : 1.2 A Effective overload current : 6.0 A Inrush current waveform : Fig. A (Pulse width : 1 ms, Wave height : 6.0 A) Numbers to withstand inrush current : 100,000 times Category temperature : 85°C

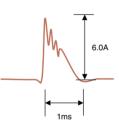


Fig. A : Inrush current waveform

2. Calculation from operating current

2-1 Measurement of operating current

Using an oscilloscope or equivalents, measure operating current (effective current) of the actual circuit. Example : Effective operating current = 1.2 A

2-2 Derating

①Temperature derating factor

Using Fig. B, find the temperature derating factor correspond to the temperature. (2) Rated derating factor

Rated derating factor = 0.75

Use Formula 1 to calculate the rated current of the fuse to be used for the circuit. Rated current of fuse \geq Operating current/ (1×2) ... Formula 1

Fig. B 140 120 100 Derating factor 80 60 40 KAB temperatu 20 0 -50 -25 0 25 50 75 100 125 Temperature (°C)

The above calculation result shows that the fuse with rated current of 1.78 A or more should be selected for this circuit. Type KAB with <u>rated current of 2.0 A or more</u> can be selected.



- 3. Calculation from overload current
- 3–1 Measurement of overload current

Using an oscilloscope or equivalents, measure the overload current that needs to break the circuit. Example : Effective overload current = 6.0 A

3-2 Calculation from overload current

Determine the rated current so that the overload current can be 2 times larger than the rated current. Use Formula 2 to calculate the rated current of the fuse.

Rated current of fuse \leq Overload current/2.0 ... Formula 2

Example : Overload current = 6.0 AUse Formula 2 to calculate the rated current. Rated current $\leq 6.0/2.0 = 3.0 \text{ A}$

The above calculation result shows that the fuse with rated current of 3.0 A or less should be selected for this circuit.

Type KAB, with rated current of 2.5 A or less can be selected.

4. Calculation from inrush current

- 4–1 Measurement of inrush current waveform Using an oscilloscope or equivalent, measure the waveform of the inrush current of the actual circuit.
- 4–2 Creation of approximate waveform Generally, the waveform of inrush current is complicated. For this reason, create the approximate waveform of inrush current as shown on Fig. C to simplify calculation.
- 4–3 Calculation of I²t of inrush current Calculate I²t (Joule integral) of the approximate waveform.

The formula for this calculation depends on the approximate waveform. Refer to Table A.

Example : Pulse applied = 1 ms, Peak value = 6.0 A, Approximate waveform = Triangular wave Since the approximate waveform is a triangular wave, use the following formula for calculation $l^{2}t$ of rush current = $1/3 \times lm^{2} \times t$... Formula 3 (lm : Peak value, t : Pulse applying time) Use Formula 3 to calculate the $l^{2}t$ of the rush current : $l^{2}t = 1/3 \times 6 \times 6 \times 0.001 = 0.012$ (A²s)

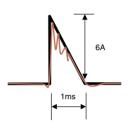


Fig. C : Inrush current waveform Red line : Actual measurement waveform Black line : Approximate waveform

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JOULE-INTEGRAL VALUES FOR EACH WAVEFORM

					Table A
Name	Waveform	l ² t	Name	Waveform	l ² t
Sine wave (1 cycle)	0 $\frac{1}{2}$ t	$\frac{1}{2}$ Im ² t	Trapezoidal wave	$0 \xrightarrow{t_1 t_2 t_3} \lim_{t_3 t_3 t_3 $	$\frac{\frac{1}{3} \operatorname{Im}^{2} t_{1} + \operatorname{Im}^{2} (t_{2} - t_{1}) + }{\frac{1}{3} \operatorname{Im}^{2} (t_{3} - t_{2})}$
Sine wave (half cycle)		$\frac{1}{2}$ lm ² t	Various wave 1		$ 1 _{2}t + \frac{1}{3}(1- _{2})^{2}t$
Triangular wave		$\frac{1}{3}$ lm ² t	Various wave 2		$\frac{\frac{1}{3} _{1}^{2}t_{1}+\left\{ _{1} _{2}+\frac{1}{3}(_{1}- _{2})^{2}\right\}}{(t_{2}-t_{1})+\frac{1}{3} _{2}^{2}(t_{3}-t_{2})}$
Rectangular wave		lm ² t	Charge/ discharge waveform	$0.368 \text{ Im} \underbrace{\stackrel{i (t) = \text{ Im e}}{0} \frac{-v\tau}{\tau}}_{0 \text{ -t}}$	$\frac{1}{2}$ lm ² τ

* Following formula is generally used for calculation of l^2t as i(t) equal to current.

 $I^{2}t = \int_{0}^{t} i^{2}(t) dt$

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4-4 Search of load ratio

- ①Set up the number of cycles to withsand. (generally 100,000 times)
- ②Obtain the load ratio from Pulse resistance characteristics. (Fig. D)
- Example : 100,000 times is required against inrush current applied.

Determine the load ratio using Fig. D.

- If the rated current is 0.2 ~ 2.0 A : 30% or less
- If the rated current is $2.5 \sim 4.0$ A : 26% or less If the rated current is $5.0 \sim 6.3$ A : 22% or less

4–5 Calculation from Joule integral and load ratio Use Formula 4 to calculate the standard I²t for the fuse to be used.

Standard I²t of fuse > (I²t of inrush current/load ratio)Formula 4

Example : I^2t of pulse = 0.012 A²s,

Required load ratio = 30% (at 0.2 ~ 2.0 A Fuse), 26% (at 2.5 ~ 4.0 A Fuse) or 22% (at 5.0 ~ 6.3 A Fuse)

Example of 2.0 A Fuse : Use Formula 4 to calculate the standard I²t of fuse. Standard I²t of fuse > 0.012/0.3 = 0.04 (A²s)

The standard I^2t of the fuse should be 0.04 (A^2s) or more.

Since the rush pulse applied is 1 ms, obtain the intersection of 1 ms (horizontal axis) and 0.04 A^2s (vertical axis) from Fig. E (refer to the arrow shown on Fig. E).

*Fig. E shows the Joule integral curves for size 1608. For size 2012, use the Joule integral curves for the size.

Select a fuse whose curve is above the intersection. Type KAB, with <u>rated current of 1.6 A or more</u> should be selected.

5. Final determination of rated value

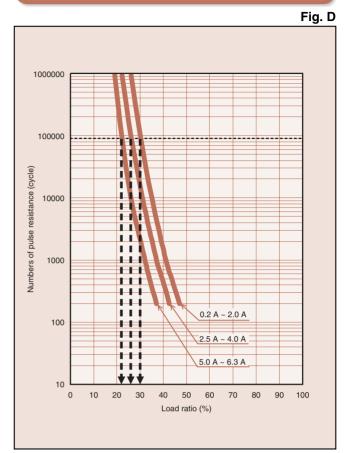
Determine the rated current of the microfuse. The rated current should meet all the above calculation results.

Example : 2.0 A and 2.5 A meet the all requirements.

6. Operation check using actual device

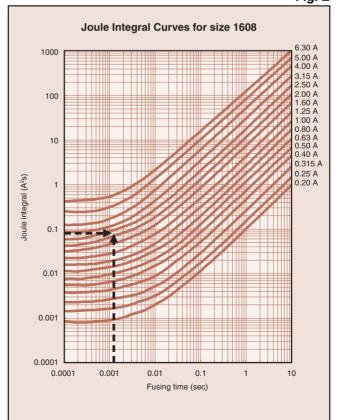
After selecting the rating, confirm if the device works properly under the pre-determined conditions.

PULSE RESISTANCE CHARACTERISTCS



JOULE INTEGRAL VS. FUSING TIME

Fig. E



Application Notes for Micro Fuse

Circuit Design Micro Fuse should be designated only after confirming operating conditions and the Micro Fuse performance characteristics. When determining the rated current, be sure to observe the

following items : (1) Micro Fuse should always be operated below the rated

 Micro Fuse should always be operated below the rated current (the value considered in the temperature derating rate) and voltage specifications.

- (2) Micro Fuse should always be operated below the rated voltage.
- (3) Micro Fuse should be selected with correct rated value to be fused at overload current.
- (4) When Micro Fuse are used in inrush current applications,
- please confirm sufficiently inrush resistance of Micro Fuse.(5) Please do not apply the current exceeding the breaking
- current to Micro Fuse. (6) Use Micro Fuse under the condition of category temperature.
- (7) Micro Fuse should not be used in the primary power source.

Micro Fuse should be selected by determining the operating conditions that will occur after final assembly, or estimating potential abnormalities through cycle testing.

2. Assembly and Mounting

During the entire assembly process, observe Micro Fuse body temperature and the heating time specified in the performance table. In addition, observe the following items :

 Mounting and adjusting with soldering irons are not recommendable since temperature and time control is difficult. In case of emergency for using soldering irons, be sure to

observe the conditions specified in the performance table.(2) Micro Fuse body should not have direct contact with a

- soldering iron.
- (3) Once Micro Fuse mounted on the board, they should never be remounted on boards or substrates.
- (4) During mounting, be careful not to apply any excessive mechanical stresses to the Micro Fuse.

3. Solvents

For cleaning of Micro Fuse, immersion in isopropyl alcohol for 90 seconds (at 20 \sim 30°C liquid temp.) will not be damaged.

If organic solvents (Pine Alpha[™], Techno Care[™], Clean Through[™], etc.) will be applied to the Micro Fuse, be sure to preliminarily check that the solvent will not damage the Micro Fuse.

4. Ultrasonic Cleaning

Ultrasonic cleaning is not recommended for Micro Fuse. This may cause damage to the Micro Fuse such as broken terminals which results in electrical characteristics effects, etc. depending on the conditions.

If Ultrasonic cleaning process must be used, please evaluate the effects sufficiently before use.

5. Caution During Usage

- Micro Fuse with electricity should never be touched. Micro Fuse with electricity may cause burning due to the Micro Fuse high temperature. Also, in case of touching Micro Fuse without electricity, please check the safety temperature of Micro Fuse.
- (2) Protective eyeglasses should always be worn when performing fusing tests. However, there is a fear that Micro Fuse will explode during test. During fusing tests, please cover particles not to fly outward from the board or testing fixture. Caution is necessary during usage at all times.

6. Environmental Conditions

- (1) Micro Fuse should not be operated in acid, alkali, or active gas atmosphere.
- (2) Micro Fuse should not be vibrated, shocked, or pressed excessively.
- (3) Micro Fuse should not be operated in a flammable or explosive atmosphere.
- (4) After mounting Micro Fuse on a board, covering Fuses with resin may affect to the electric characteristics of the Micro Fuse. Please be sure to evaluate it in advance.

7. Emergency

In case of fire, smoking, or offensive odor during operation, please cut off the power in the circuit or pull the plug out.

8. Storage

- Micro Fuse should be stored at room temperature (-10°C ~ +40°C) without direct sunlight. Direct sunlight may cause decolorization and deformation of the exterior and taping. Also, there is a fear that solderability will be remarkably lower in high humidity.
- (2) If the products are stored for an extended period of time, please contact Matsuo Sales Department for recommendation. The longer storage term causes packages and tapings to worsen. If the products are stored for longer term, please contact Matsuo Sales Department for advice.
- (3) The products in taping, package, or box should not be given any kind of physical pressure. Deformation of taping or package may affect automatic mounting.

9. Disposal

When Micro Fuse are disposed of as waste or "scrap", they should be treated as "industrial waste". Micro Fuse contain various kinds of metals and resins.

10. Samples

Micro Fuse received as samples should not be used in any products or devices in the market. Samples are provided for a particular purpose such as configuration, confirmation of electrical characteristics, etc.

🛄 MATSUO ELECTRIC CO., LTD.

Please feel free to ask our sales department for more information on the Micro Fuse.

Overseas Sales Dep. :	5-3, 3-Chome, Sennari-cho, Toyonaka-shi, Osaka 561-8558, Japan	Tel : 06-6332-0883	Fax : 06-6332-0920
USA :	Matsuo Electronics of America, Inc. 2134 Main Street, Suite 200, Huntington Beach, CA 92648	Tel : 714-969-2491	Fax : 714-960-6492
Head Office :	5-3, 3-Chome, Sennari-cho, Toyonaka-shi, Osaka 561-8558, Japan	Tel : 06-6332-0871	Fax : 06-6331-1386
URL :	http://www.ncc-matsuo.co.jp/		

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